

YNV12T100xy

DC-DC Converter Series

9.6 - 14 VDC Input; 1.0 - 5.0 VDC
Programmable @ 10 A



Key Features & Benefits

- RoHS lead-free solder and lead-solder-exempted products are available
- Delivers up to 10 A (50 W)
- Industry-standard footprint and pinout
- Single-in-Line Package (SIP): 2.0" x 0.575" x 0.28" (50.8 x 14.59 x 7.11 mm)
- Weight: 0.25 oz [7 g]
- Synchronous Buck Converter topology
- Start-up into pre-biased output
- No minimum load required
- Output voltage trim +/-10%
- Operating ambient temperature: -40 °C to 85 °C
- Remote output sense
- Remote ON/OFF (positive or negative)
- Fixed-frequency operation
- Auto-reset output overcurrent protection
- Auto-reset overtemperature protection
- High reliability, MTBF = TBD Million Hours
- All materials meet UL94, V-0 flammability rating
- Safety approved to UL/CSA 62368-1 and EN/IEC 62368-1

Bel Power Solutions point-of-load converters are recommended for use with regulated bus converters in an Intermediate Bus Architecture (IBA). The YNV12T100xy family of non-isolated DC-DC converters deliver up to 10 A of output current in an industry-standard through hole (SIP) package. The YNV12T100xy converters operate from a 9.6 -14 VDC input, and are ideal choices for Intermediate Bus Architectures where point-of-load power delivery is generally a requirement.

Within the YNV12T100xy family, converters come in individual output voltage versions, allowing coverage of the output voltage range from 1.0 V to 5.0 V. Each version is capable of providing an extremely tight, highly regulated, and trimmable output.

The YNV12T100xy converters provide exceptional thermal performance, even in high temperature environments with minimal airflow. No derating is required for temperatures up to 70 °C under natural convection conditions. This is accomplished through the use of circuitry, packaging, and processing techniques to achieve ultra-high efficiency, excellent thermal management, and a very sleek body profile.

The sleek body profile and the preclusion of heat sinks minimize impedance to system airflow, thus enhancing cooling for both upstream and downstream devices. The use of 100% automation for assembly, coupled with advanced power electronics and thermal design, results in a product with extremely high reliability.

Applications

- Intermediate Bus Architectures
- Telecommunications
- Data Communications
- Distributed Power Architectures
- Servers, Workstations

Benefits

- High efficiency – no heat sink required
- Reduces Total Solution Board Area

ELECTRICAL SPECIFICATIONS

Conditions: $T_A = 25\text{ }^\circ\text{C}$, Airflow = 200 LFM (1 m/s), $V_{in} = 12\text{ VDC}$, $V_{out} = 1.0 - 5.0\text{ V}$, unless otherwise specified.

PARAMETER	NOTES	MIN	TYP	MAX	UNITS
ABSOLUTE MAXIMUM RATINGS					
Input Voltage	Continuous	-0.3		15	VDC
Operating Ambient Temperature		-40		85	$^\circ\text{C}$
Storage Temperature		-55		125	$^\circ\text{C}$
FEATURE CHARACTERISTICS					
Switching Frequency			300		kHz
Output Voltage Trim Range	See Trim Equations	-10		+10	%
Remote Sense Compensation				0.5	VDC
Turn-On Delay Time ¹	Full resistive load				
With $V_{in} =$ (Converter Enabled, then V_{in} applied)	From $V_{in} = V_{in}(\text{min})$ to $V_o = 0.1 * V_o(\text{nom})$		3.5		ms
With Enable ($V_{in} = V_{in}(\text{nom})$ applied, then enabled)	From enable to $V_o = 0.1 * V_o(\text{nom})$		3.5		ms
Rise time ¹	From 10% to 90%, full resistive load		3.5		ms
ON/OFF Control (Positive Logic) ²	Converter Off	-5		0.8	VDC
	Converter On	2.4		V_{IN}	VDC
ON/OFF Control (Negative Logic) ²	Converter Off	2.4		V_{IN}	VDC
	Converter On	-5		0.8	VDC
INPUT CHARACTERISTICS					
Operating Input Voltage Range		9.6	12	14	VDC
Input Under Voltage Lockout					
Turn-on Threshold			9.0		VDC
Turn-off Threshold			8.5		VDC
Maximum Input Current	10 ADC Out @ 9.6 VDC In				
	$V_{OUT} = 5.0\text{ VDC}$			6.0	ADC
	$V_{OUT} = 3.3\text{ VDC}$			4.0	ADC
	$V_{OUT} = 2.5\text{ VDC}$			3.1	ADC
	$V_{OUT} = 2.0\text{ VDC}$			2.5	ADC
	$V_{OUT} = 1.8\text{ VDC}$			2.2	ADC
	$V_{OUT} = 1.5\text{ VDC}$			1.9	ADC
	$V_{OUT} = 1.2\text{ VDC}$			1.6	ADC
	$V_{OUT} = 1.0\text{ VDC}$			1.3	ADC
Input Stand-by Current (converter disabled)			5		mA
Input No Load Current (converter enabled)	$V_{OUT} = 5.0\text{ VDC}$		80		mA
	$V_{OUT} = 3.3\text{ VDC}$		60		mA
	$V_{OUT} = 2.5\text{ VDC}$		50		mA
	$V_{OUT} = 2.0\text{ VDC}$		45		mA
	$V_{OUT} = 1.8\text{ VDC}$		40		mA
	$V_{OUT} = 1.5\text{ VDC}$		37		mA
	$V_{OUT} = 1.2\text{ VDC}$		35		mA
	$V_{OUT} = 1.0\text{ VDC}$		33		mA
Input Reflected-Ripple Current - i_s	See Fig. F for setup. (BW = 20 MHz)		TBD		mA _{P-P}
Input Voltage Ripple Rejection	120 Hz		72		dB

OUTPUT CHARACTERISTICS				
Output Voltage Set Point (no load)		-1.5	Vout	+1.5 %Vout
Output Regulation				
Over Line	Full resistive load		0.5	2 mV
Over Load	From no load to full load		5	15 mV
Output Voltage Range	(Overall operating input voltage, resistive load and temperature conditions until end of life)	-2.5		+2.5 %Vout
Output Ripple and Noise - 20 MHz bandwidth (Fig. F) Over line, load and temperature				
Peak-to-Peak	V _{OUT} = 1.0 VDC		10	20 mV _{P-P}
Peak-to-Peak	V _{OUT} = 5.0 VDC		25	40 mV _{P-P}
External Load Capacitance Plus full load (resistive)				
Min. ESR > 1 mΩ				1000 μF
Min. ESR > 10 mΩ				5000 μF
Output Current Range		0		10 ADC
Output Current Limit Inception (I _{OUT})			15	A
Output Short- Circuit Current	Short=10 mΩ, continuous		2	A _{rms}
DYNAMIC RESPONSE				
load step from 5 A to 10 A with di/dt = 5 A/μs	Co = 100 μF ceramic		120 ³	mV
Settling Time (V _{OUT} < 10% peak deviation)			60	μs
load step change from 10 A – 5 A with di/dt = -5 A/μs	Co = 100 μF ceramic		120 ³	mV
Settling Time (V _{OUT} < 10% peak deviation)			60	μs
EFFICIENCY				
	Full load (10A)			
	V _{OUT} = 5.0 VDC		94.0	%
	V _{OUT} = 3.3 VDC		93.0	%
	V _{OUT} = 2.5 VDC		92.0	%
	V _{OUT} = 2.0 VDC		90.5	%
	V _{OUT} = 1.8 VDC		90.0	%
	V _{OUT} = 1.5 VDC		88.5	%
	V _{OUT} = 1.2 VDC		87.0	%
	V _{OUT} = 1.0 VDC		85.0	%

Notes:

- ¹ Note that start-up time is the sum of turn on delay and rise time.
- ² Converter is on if ON/OFF pin is left open.
- ³ See attached waveforms for dynamic response and settling time for different output voltages.

OPERATIONS

Input and Output Impedance

YNV12T100xy converters should be connected via a low impedance to the DC power source. In many applications, the inductance associated with the distribution from the power source to the input of the converter can affect the stability of the converter. It is recommended to use decoupling capacitors in order to ensure stability of the converter and reduce input ripple voltage. The converter has an internal input capacitance of 20 μF with very low ESR ceramic capacitors.

In a typical application, low - ESR tantalum or POS capacitors will be sufficient to provide adequate ripple voltage filtering and at the input of the converter. However, very low ESR ceramic capacitors 47 μF -100 μF are recommended at the input of the converter in order to minimize the input ripple voltage. They should be placed as close as possible to the input pins of the converter.

The YNV12T100xy has been designed for stable operation with or without external capacitance. Low ESR ceramic capacitors placed as close as possible to the load (Min 47 μF) are recommended for improved transient performance and lower output voltage ripple.

It is important to keep low resistance and low inductance PCB traces when connecting the load to the output pins of the converter in order to maintain good load regulation.

ON/OFF (Pin 10)

The ON/OFF pin is used to turn the power converter on or off remotely via a system signal. There are two remote control options available, positive logic (standard option) and negative logic, and both are referenced to GND. Typical connections are shown in Fig. A.

The positive logic version turns the converter on when the ON/OFF pin is at a logic high or left open, and turns the converter off when at a logic low or shorted to GND.

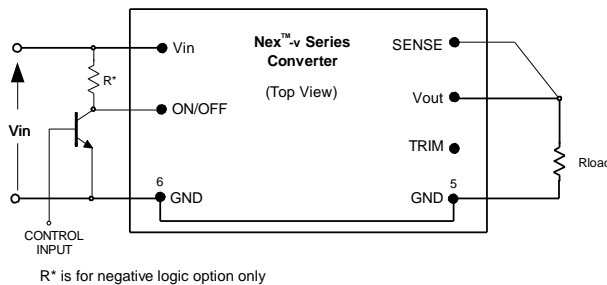


Fig. A: Circuit configuration for ON/OFF function.

The negative logic version turns the converter on when the ON/OFF pin is at a logic low or left open, and turns the converter off when the ON/OFF pin is at a logic high or connected to Vin.

ON/OFF pin is internally pulled-up to Vin for positive logic version, and pulled-down for negative logic version. A TTL or CMOS logic gate, open collector (open drain) transistor can be used to drive ON/OFF pin. When using open collector (open drain) transistor with a negative logic option, add a pull-up resistor (R^*) of 75K to Vin as shown in Fig. A; This device must be capable of:

- sinking up to 0.2 mA at a low level voltage of $\leq 0.8\text{V}$
- sourcing up to 0.25 mA at a high logic level of 2.3V – 5V
- sourcing up to 0.75 mA when connected to Vin.

Remote Sense (Pin 3)

The remote sense feature of the converter compensates for voltage drops occurring only between Vout pins of the converter and the load. The SENSE pin (Pin 3) should be connected at the load or at the point where regulation is required (see Fig. B). There is no sense feature on the output GND return pin, where the solid ground plane should provide low voltage drop.

If remote sensing is not required, the SENSE pin must be connected to any of the Vout pins to ensure the converter will regulate at the specified output voltage. If these connections are not made, the converter will deliver an output voltage that is slightly higher than the specified value.

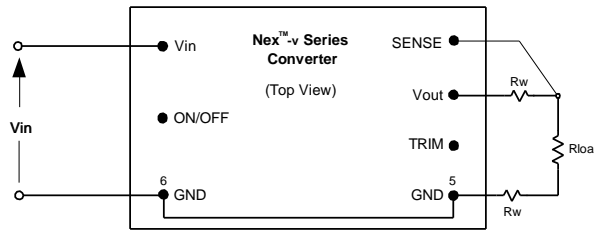


Fig. B: Remote sense circuit configuration.

Because the sense lead carries minimal current, large trace on the end-user board is not required. However, the sense trace should be located close to a ground plane to minimize system noise and insure optimum performance.

When utilizing the remote sense feature, care must be taken not to exceed the maximum allowable output power capability of the converter, equal to the product of the nominal output voltage and the allowable output current for the given conditions.

When using remote sense, the output voltage at the converter can be increased up to 0.5 V above the nominal rating in order to maintain the required voltage across the load. Therefore, the designer must, if necessary, decrease the maximum current (originally obtained from the derating curves) by the same percentage to ensure the converter's actual output power remains at or below the maximum allowable output power.

Output Voltage Adjust /TRIM (Pin 9)

The output voltage can be adjusted up 10% or down 10% using external resistor.

To trim up the output voltage, refer to Fig. C. A trim resistor, R_{T-INCR} , should be connected between the TRIM pin (Pin 9) and the GND pin (Pin 5), with a value of:

$$R_{T-INCR} = \frac{10.5}{(V_{O-REQ} - V_{O-NOM})} - 1 \quad [k\Omega]$$

where,

R_{T-INCR} = Required value of trim-up resistor [kΩ]

V_{O-REQ} = Desired (trimmed) output voltage [V]

V_{O-NOM} = Nominal output voltage [V]

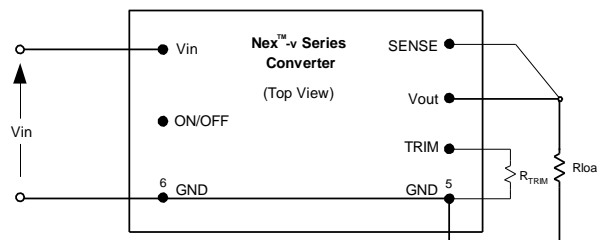


Fig. C: Configuration for increasing output voltage.

To trim down the output voltage (Fig.D), a trim resistor, R_{T-DECR} , should be connected between the TRIM pin (Pin 9) and SENSE pin (Pin 3), with a value of:

$$R_{T-DECR} = \frac{(V_{O-REQ} - 0.7) * 15}{(V_{O-NOM} - V_{O-REQ})} - 1 \quad [k\Omega]$$

where,

R_{T-DECR} = Required value of trim-down resistor [k Ω]

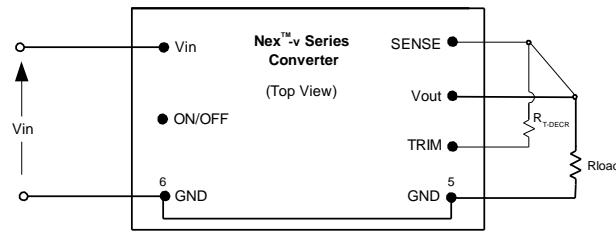


Fig. D: Configuration for programming output voltage.

Table 1 and Table 2 provide the values of resistor for trimming up and down respectively. Standard 1% and 5% resistors can be used for trimming. Ground pin of the trim resistor should be connected directly to the converter GND pin (Pin 5) with no voltage drop in between. In Table 1 and Table 2, Δ is a percentage of increase or decrease of V_{O-NOM} .

Δ [%]	Nominal value of output voltage V_{O-NOM} [V]							
	1.0	1.2	1.5	1.8	2.0	2.5	3.3	5.0
1	1049	874	699	582	524	419	317	209
2	524	437	349	291	262	209	158	104
3	349	291	232	193	174	139	105	69
4	262	218	174	145	130	104	79	52
5	209	174	139	116	104	83	63	41
6	174	145	116	96	87	69	52	34
7	149	124	99	82	74	59	44	29
8	130	108	87	72	65	52	39	25
9	116	96	77	64	57	46	34	22
10	104	87	69	57	52	41	31	20

Table 1: Trim-up Resistor R_{T-INCR} [k Ω]

Δ [%]	Nominal value of output voltage V_{O-NOM} [V]							
	1.0	1.2	1.5	1.8	2.0	2.5	3.3	5.0
-1	434	609	784	901	959	1064	1166	1274
-2	209	297	384	442	472	524	575	629
-3	134	192	251	290	309	344	378	414
-4	97	140	184	213	228	254	279	307
-5	74	109	144	167	179	200	220	242
-6	59	88	117	137	147	164	181	199
-7	48	73	98	115	123	138	153	168
-8	40	62	84	99	106	119	132	145
-9	34	53	73	86	92	104	115	127
-10	29	47	64	76	82	92	102	113

Table 2: Trim-down Resistor R_{T-DECR} [k Ω]

PROTECTION FEATURES

Input Undervoltage Lockout

Input undervoltage lockout is standard with this converter. The converter will shut down when the input voltage drops below a pre-determined voltage; it will start automatically when V_{in} returns to a specified range.

The input voltage must be at least 9.6 V (typically 9 V) for the converter to turn on. Once the converter has been turned on, it will shut off when the input voltage drops below typically 8.5 V.

Output Overcurrent Protection (OCP)

The converter is protected against overcurrent and short-circuit conditions. Upon sensing an overcurrent condition, the converter will enter hiccup mode. Once overload or short-circuit condition is removed, V_{out} will return to nominal value.

Overtemperature Protection (OTP)

The converter will shut down under an overtemperature condition to protect itself from overheating caused by operation outside the thermal derating curves, or operation in abnormal conditions such as system fan failure. After the converter has cooled to a safe operating temperature, it will automatically restart.

Safety Requirements

Approved to the latest edition and amendment of ITE Safety standards, UL/CSA 62368-1 and EN/IEC 62368-1

The maximum DC voltage between any two pins is V_{in} under all operating conditions. Therefore, the unit has ELV (extra low voltage) output; it meets ES1 requirements under the condition that all input voltages are ELV.

The converter is not internally fused. To comply with safety agencies requirements, a recognized fuse with a maximum rating of 15 Amps must be used in series with the input line.

CHARACTERIZATION

General Information

The converter has been characterized for many operational aspects, to include thermal derating (maximum load current as a function of ambient temperature and airflow) for vertical and horizontal mounting, efficiency, start-up and shutdown parameters, output ripple and noise, transient response to load step-change, overload, and short circuit.

The figures are numbered as Fig. x.y, where x indicates the different output voltages, and y associates with specific plots (y = 1 for the vertical thermal derating, ...). For example, Fig. x.1 will refer to the vertical thermal derating for all the output voltages in general.

The following pages contain specific plots or waveforms associated with the converter. Additional comments for specific data are provided below.

Test Conditions

All thermal and efficiency data presented were taken with the converter soldered to a test board, specifically a 0.060" thick printed wiring board (PWB) with four layers. The top and bottom layers were not metalized. The two inner layers, comprising two-ounce copper, were used to provide traces for connectivity to the converter.

The lack of metalization on the outer layers as well as the limited thermal connection ensured that heat transfer from the converter to the PWB was minimized. This provides a worst-case but consistent scenario for thermal derating purposes.

All measurements requiring airflow were made in vertical and horizontal wind tunnel facilities using Infrared (IR) thermography and thermocouples for thermometry.

Ensuring components on the converter do not exceed their ratings is important to maintaining high reliability. If one anticipates operating the converter at or close to the maximum loads specified in the derating curves, it is prudent to check actual operating temperatures in the application. Thermographic imaging is preferable; if this capability is not available, then thermocouples may be used. Bel Power Solutions recommends the use of AWG #40 gauge thermocouples to ensure measurement accuracy. Careful routing of the thermocouple leads will further minimize measurement error. Refer to Fig. E for optimum measuring thermocouple location.

Thermal Derating

Load current vs. ambient temperature and airflow rates are given in Figs. x.1 to x.2 for maximum temperature of 120 °C. Ambient temperature was varied between 25 °C and 85 °C, with airflow rates from 30 to 500 LFM (0.15 m/s to 2.5 m/s), and vertical and horizontal converter mounting. The airflow during the testing is parallel to the long axis of the converter, going from input pins to output pins.

For each set of conditions, the maximum load current was defined as the lowest of:

- (i) The output current at which any MOSFET temperature does not exceed a maximum specified temperature (120 °C) as indicated by the thermographic image, or
- (ii) The maximum current rating of the converter (10 A)

During normal operation, derating curves with maximum FET temperature less than or equal to 120 °C should not be exceeded. Temperature on the PCB at the thermocouple location shown in Fig. E should not exceed 120 °C in order to operate inside the derating curves.

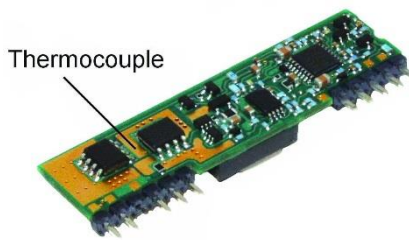


Fig. E: Location of the thermocouple for thermal testing

Efficiency

Figure x.3 shows the efficiency vs. load current plot for ambient temperature of 25 °C, airflow rate of 200 LFM (1 m/s) and input voltages of 9.6 V, 12 V, and 14 V.

Power Dissipation

Fig. x.4 shows the power dissipation vs. load current plot for $T_a = 25\text{ °C}$, airflow rate of 200 LFM (1 m/s) with vertical mounting and input voltages of 9.6 V, 12 V, and 14 V.

Ripple and Noise

The output voltage ripple waveform is measured at full rated load current. Note that all output voltage waveforms are measured across a 1 μF ceramic capacitor.

The output voltage ripple and input reflected ripple current waveforms are obtained using the test setup shown in Figure F.

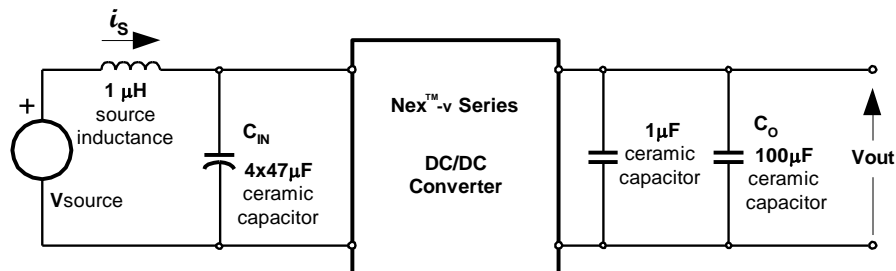


Fig. F: Test setup for measuring input reflected ripple currents, i_s and output voltage ripple

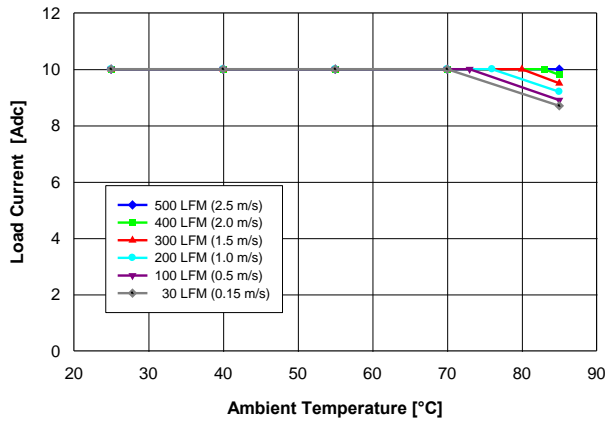


Fig. 5.0V.1: Available load current vs. ambient temperature and airflow rates for YNV12T10050 converter mounted vertically with $V_{in} = 12\text{ V}$, and maximum MOSFET temperature $\leq 120\text{ }^{\circ}\text{C}$.

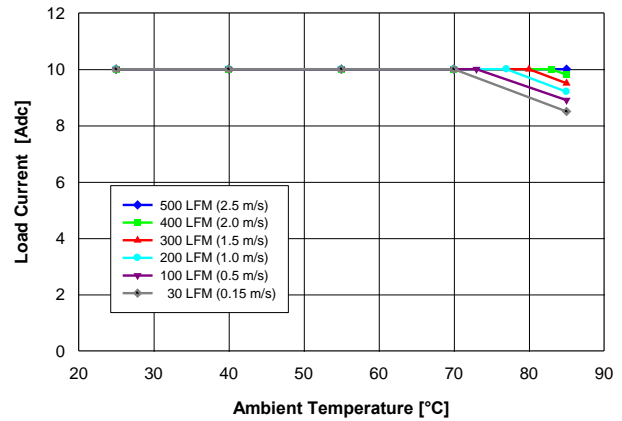


Fig. 5.0V.2: Available load current vs. ambient temperature and airflow rates for YNV12T10050 converter mounted horizontally with $V_{in} = 12\text{ V}$, and maximum MOSFET temperature $\leq 120\text{ }^{\circ}\text{C}$.

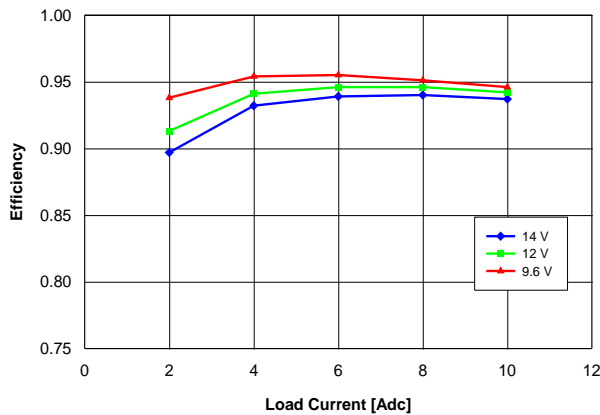


Fig. 5.0V.3: Efficiency vs. load current and input voltage for YNV12T10050 converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and $T_a = 25\text{ }^{\circ}\text{C}$.

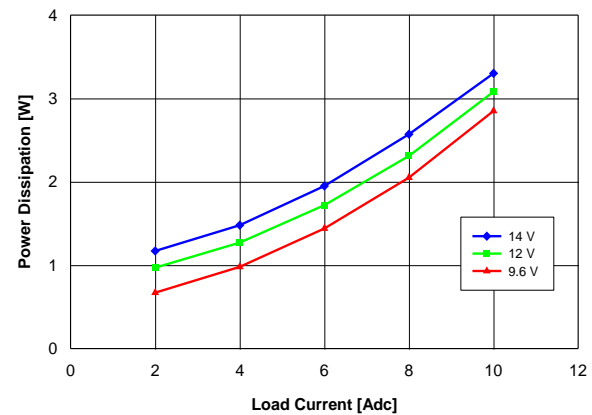


Fig. 5.0V.4: Power loss vs. load current and input voltage for YNV12T10050 converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and $T_a = 25\text{ }^{\circ}\text{C}$.

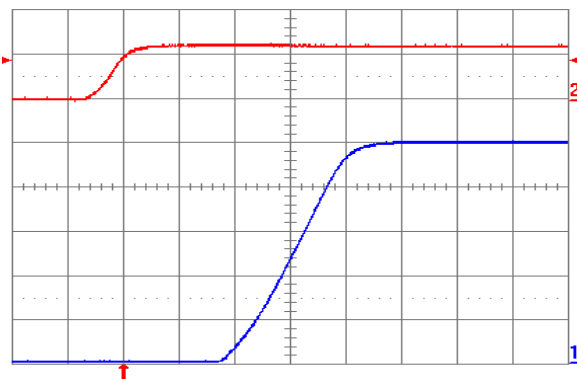


Fig. 5.0V.5: Turn-on transient (YNV12T10050) with application of V_{in} at full rated load current (resistive) and 100 μF external capacitance at $V_{in} = 12\text{ V}$. Top trace: V_{in} (10 V/div.); Bottom trace: output voltage (1 V/div.); Time scale: 2 ms/div.

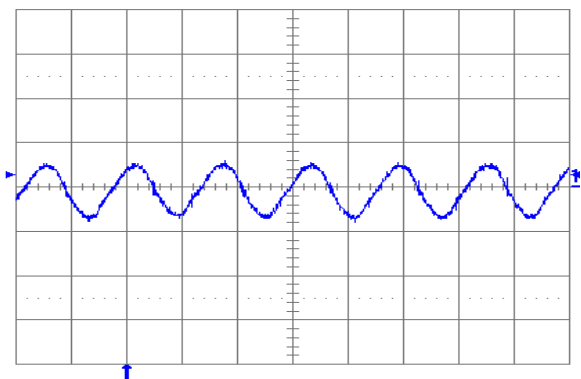


Fig. 5.0V.6: Output voltage ripple (20 mV/div.) at full rated load current into a resistive load with external capacitance 100 μF ceramic and $V_{in} = 12\text{ V}$ (YNV12T10050). Time scale: 2 μs /div.

YNV12T100xy DC-DC Converter

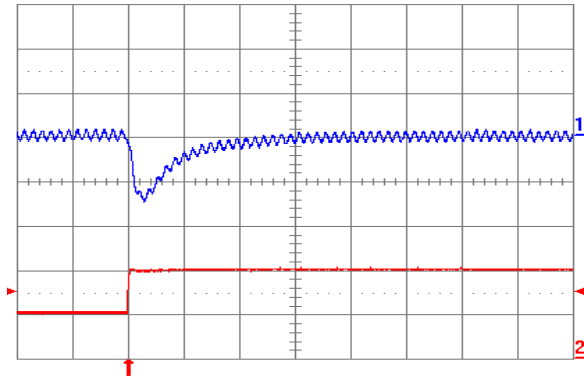


Fig. 5.0V.7: Output voltage response (YNV12T10050) to positive load current step change from 5 A to 10 A with slew rate of 5 A/μs at Vin = 12V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.

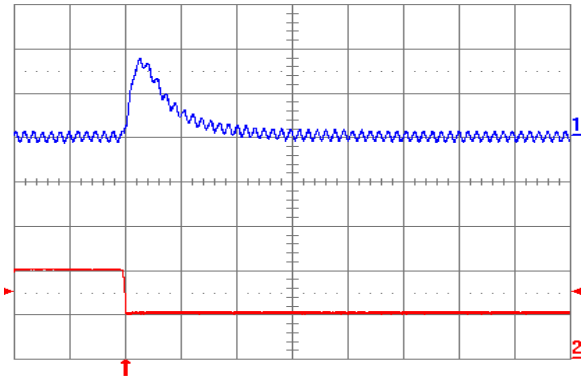


Fig. 5.0V.8: Output voltage response (YNV12T10050) to negative load current step change from 10 A to 5 A with slew rate of -5 A/μs at Vin = 12 V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). Co = 100 μF ceramic. Time scale: 20 μs/div.

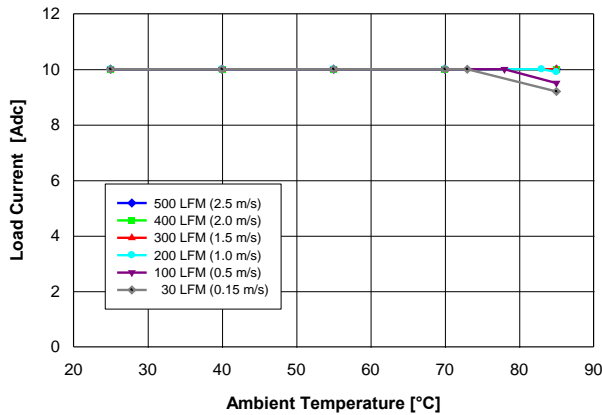


Fig. 3.3V.1: Available load current vs. ambient temperature and airflow rates for YNV12T10033 converter mounted vertically with Vin = 12 V, and maximum MOSFET temperature ≤ 120 °C.

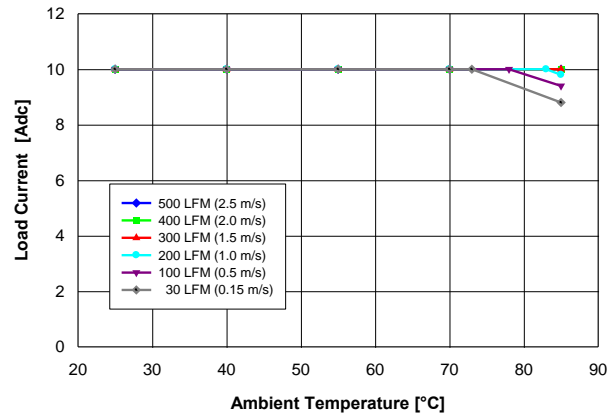


Fig. 3.3V.2: Available load current vs. ambient temperature and airflow rates for YNV12T10033 converter mounted horizontally with Vin = 12 V, and maximum MOSFET temperature ≤ 120 °C.

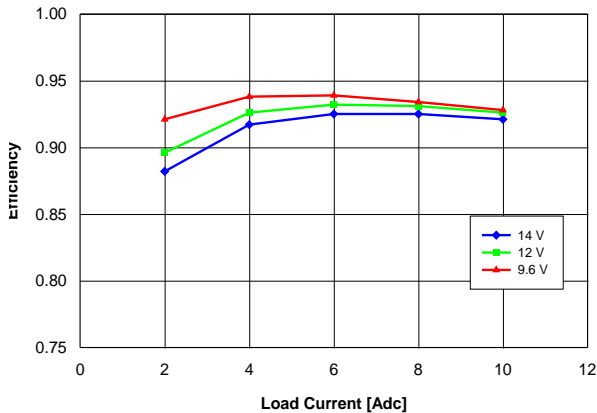


Fig. 3.3V.3: Efficiency vs. load current and input voltage for YNV12T10033 converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.

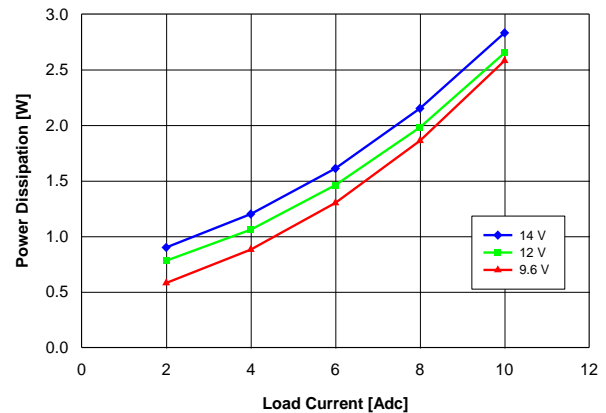


Fig. 3.3V.4: Power loss vs. load current and input voltage for YNV12T10033 converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and Ta = 25 °C.

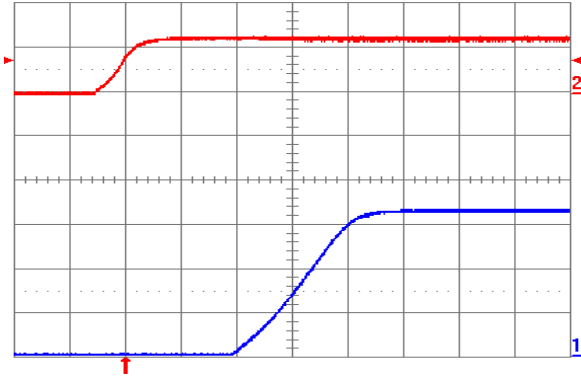


Fig. 3.3V.5: Turn-on transient (YNV12T10033) with application of V_{in} at full rated load current (resistive) and 100 μF external capacitance at $V_{in} = 12\text{ V}$. Top trace: V_{in} (10 V/div.); Bottom trace: output voltage (1 V/div.); Time scale: 2 ms/div.

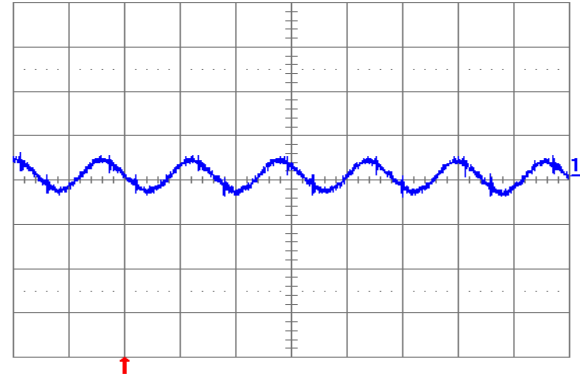


Fig. 3.3V.6: Output voltage ripple (20 mV/div.) at full rated load current into a resistive load with external capacitance 100 μF ceramic and $V_{in} = 12\text{ V}$ (YNV12T10033). Time scale: 2 μs /div.

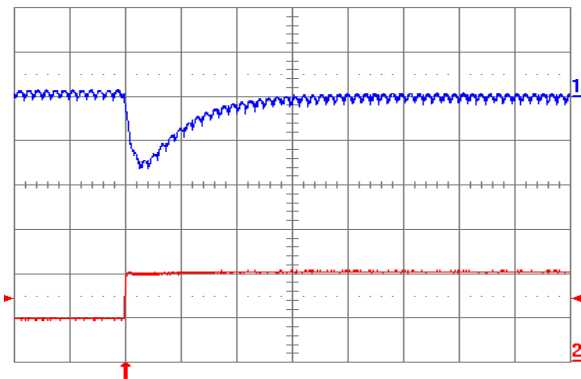


Fig. 3.3V.7: Output voltage response (YNV12T10033) to positive load current step change from 5 A to 10 A with slew rate of 5 A/ μs at $V_{in} = 12\text{ V}$. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). $C_o = 100\text{ }\mu\text{F}$ ceramic. Time scale: 20 μs /div.

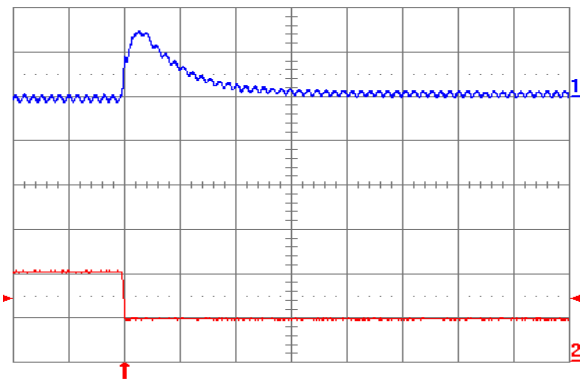


Fig. 3.3V.8: Output voltage response (YNV12T10033) to negative load current step change from 10 A to 5 A with slew rate of -5 A/ μs at $V_{in} = 12\text{ V}$. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). $C_o = 100\text{ }\mu\text{F}$ ceramic. Time scale: 20 μs /div.

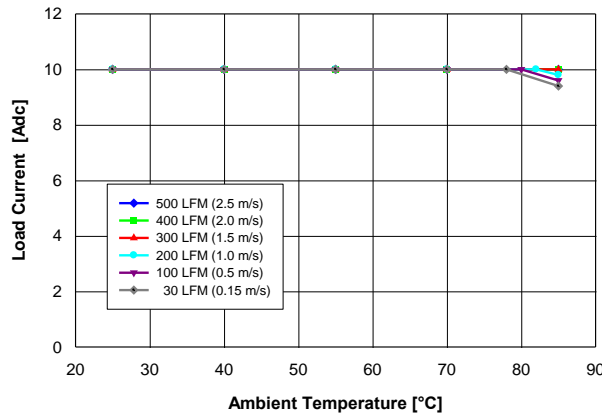


Fig. 2.5V.1: Available load current vs. ambient temperature and airflow rates for YNV12T10025 converter mounted vertically with $V_{in} = 12\text{ V}$, and maximum MOSFET temperature $\leq 120\text{ }^\circ\text{C}$.

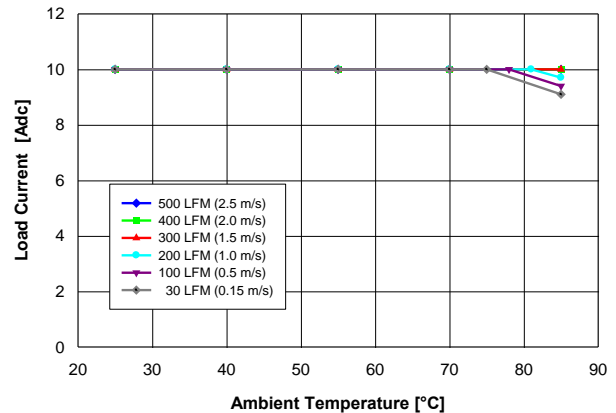


Fig. 2.5V.2: Available load current vs. ambient temperature and airflow rates for YNV12T10025 converter mounted horizontally with $V_{in} = 12\text{ V}$, and maximum MOSFET temperature $\leq 120\text{ }^\circ\text{C}$.

YNV12T100xy DC-DC Converter

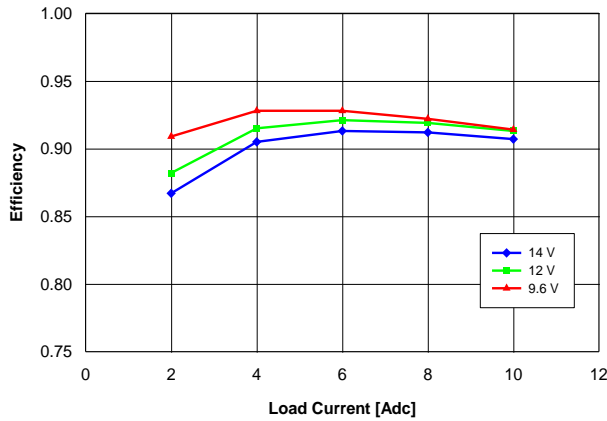


Fig. 2.5V.3: Efficiency vs. load current and input voltage for YNV12T10025 converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and $T_a = 25^\circ\text{C}$.

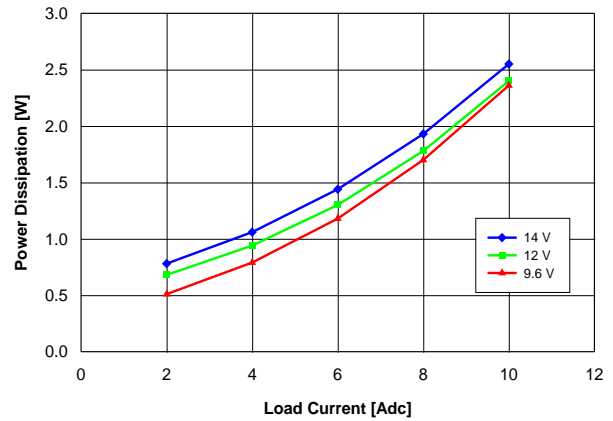


Fig. 2.5V.4: Power loss vs. load current and input voltage for YNV12T10025 converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and $T_a = 25^\circ\text{C}$.

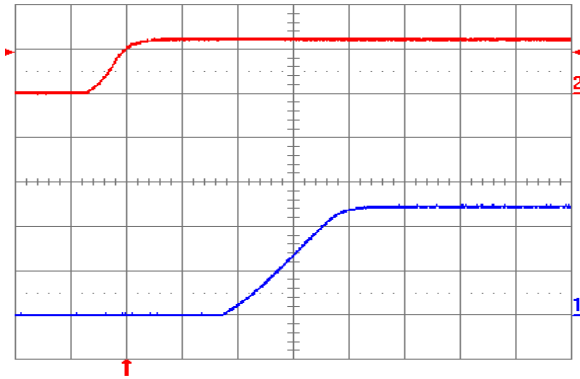


Fig. 2.5V.5: Turn-on transient (YNV12T10025) with application of V_{in} at full rated load current (resistive) and $100\ \mu\text{F}$ external capacitance at $V_{in} = 12\ \text{V}$. Top trace: V_{in} (10 V/div.); Bottom trace: output voltage (1 V/div.); Time scale: 2 ms/div.

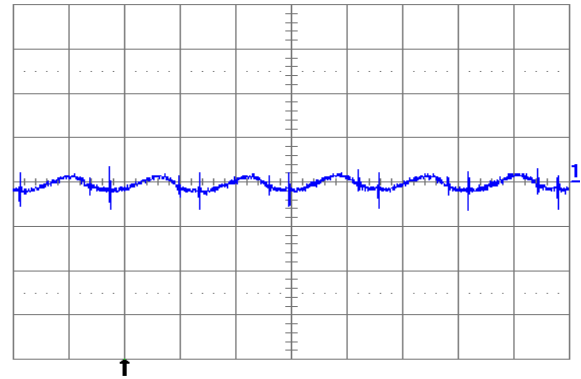


Fig. 2.5V.6: Output voltage ripple (20 mV/div.) at full rated load current into a resistive load with external capacitance $100\ \mu\text{F}$ ceramic and $V_{in} = 12\ \text{V}$ (YNV12T10025). Time scale: $2\ \mu\text{s}/\text{div}$.

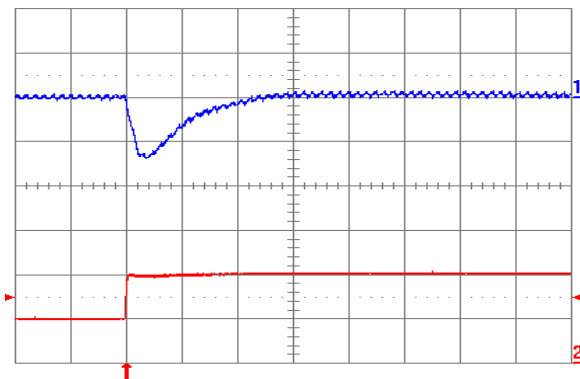


Fig. 2.5V.7: Output voltage response (YNV12T10025) to positive load current step change from 5 A to 10 A with slew rate of $5\ \text{A}/\mu\text{s}$ at $V_{in} = 12\ \text{V}$. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). $C_o = 100\ \mu\text{F}$ ceramic. Time scale: $20\ \mu\text{s}/\text{div}$.

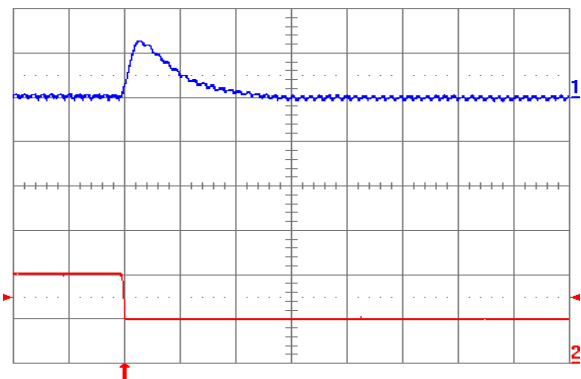


Fig. 2.5V.8: Output voltage response (YNV12T10025) to negative load current step change from 10 A to 5 A with slew rate of $-5\ \text{A}/\mu\text{s}$ at $V_{in} = 12\ \text{V}$. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). $C_o = 100\ \mu\text{F}$ ceramic. Time scale: $20\ \mu\text{s}/\text{div}$.

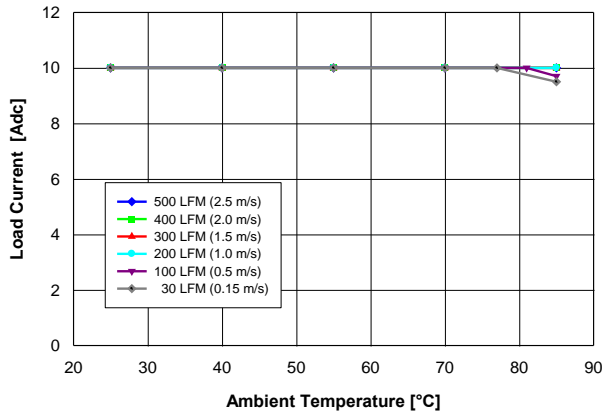


Fig. 2.0V.1: Available load current vs. ambient temperature and airflow rates for YNV12T10020 converter mounted vertically with $V_{in} = 12\text{ V}$, and maximum MOSFET temperature $\leq 120\text{ }^{\circ}\text{C}$.

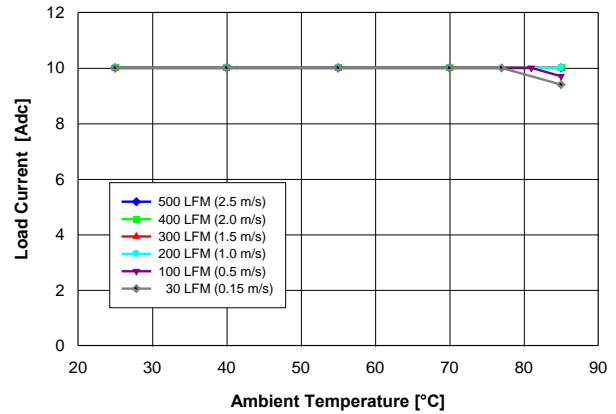


Fig. 2.0V.2: Available load current vs. ambient temperature and airflow rates for YNV12T10020 converter mounted horizontally with $V_{in} = 12\text{ V}$, and maximum MOSFET temperature $\leq 120\text{ }^{\circ}\text{C}$.

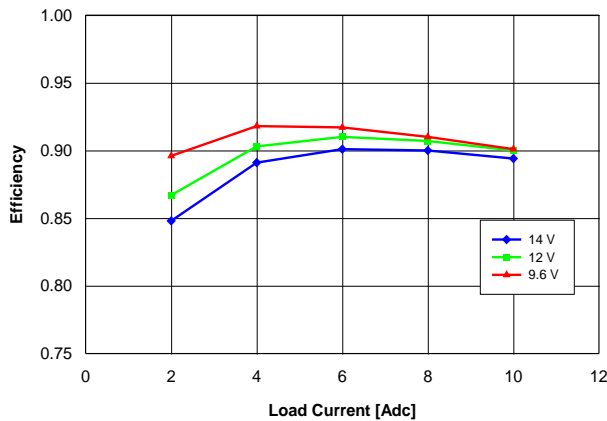


Fig. 2.0V.3: Efficiency vs. load current and input voltage for YNV12T10020 converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and $T_a = 25\text{ }^{\circ}\text{C}$.

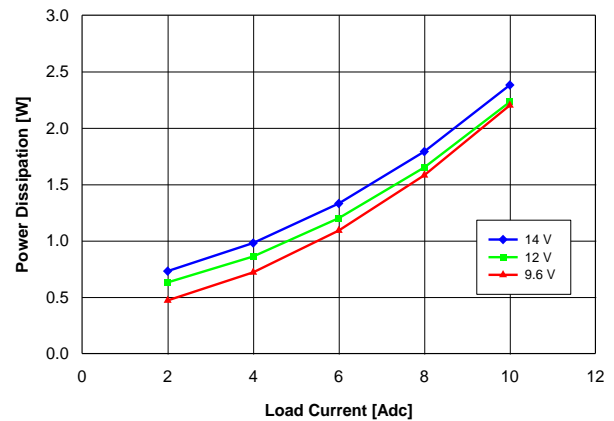


Fig. 2.0V.4: Power loss vs. load current and input voltage for YNV12T10020 converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and $T_a = 25\text{ }^{\circ}\text{C}$.

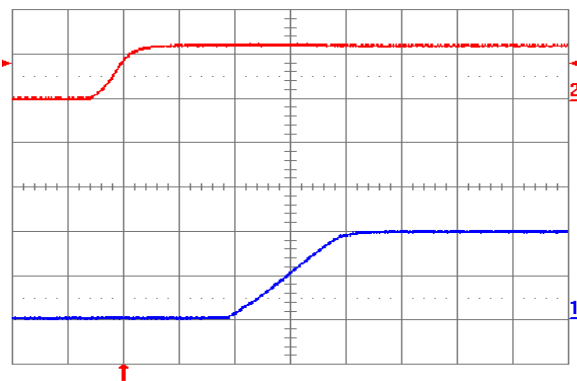


Fig. 2.0V.5: Turn-on transient (YNV12T10020) with application of V_{in} at full rated load current (resistive) and $100\text{ }\mu\text{F}$ external capacitance at $V_{in} = 12\text{ V}$. Top trace: V_{in} (10 V/div.); Bottom trace: output voltage (1 V/div.); Time scale: 2 ms/div.

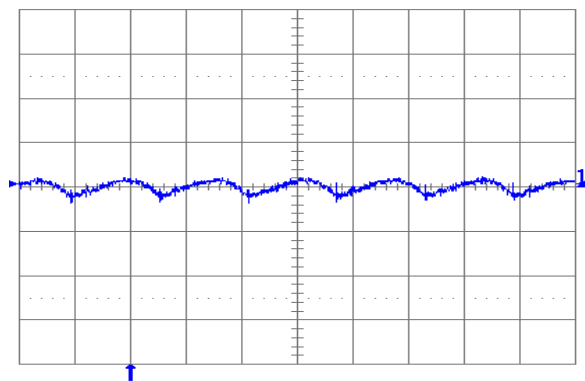


Fig. 2.0V.6: Output voltage ripple (20 mV/div.) at full rated load current into a resistive load with external capacitance $100\text{ }\mu\text{F}$ ceramic and $V_{in} = 12\text{ V}$ (YNV12T10020). Time scale: 2 μs /div.

YNV12T100xy DC-DC Converter

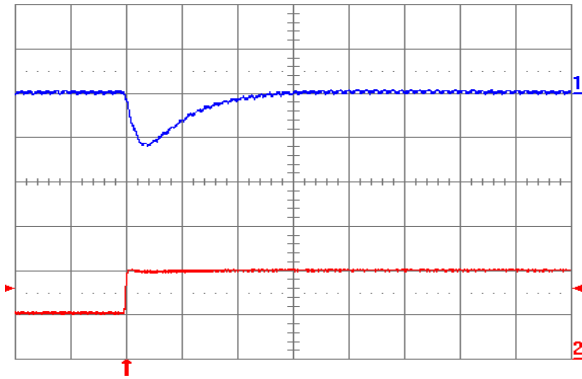


Fig. 2.0V.7: Output voltage response (YNV12T10020) to positive load current step change from 5 A to 10 A with slew rate of 5 A/μs at $V_{in} = 12$ V. Top trace: output voltage (100mV/div.); Bottom trace: load current (5 A/div.). $C_o = 100$ μF ceramic. Time scale: 20 μs/div.

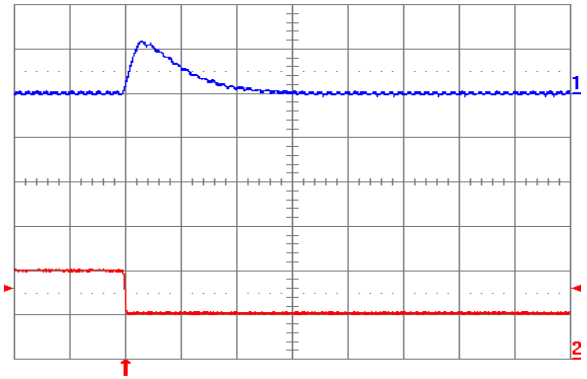


Fig. 2.0V.8: Output voltage response (YNV12T10020) to negative load current step change from 10 A to 5 A with slew rate of -5 A/μs at $V_{in} = 12$ V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). $C_o = 100$ μF ceramic. Time scale: 20 μs/div.

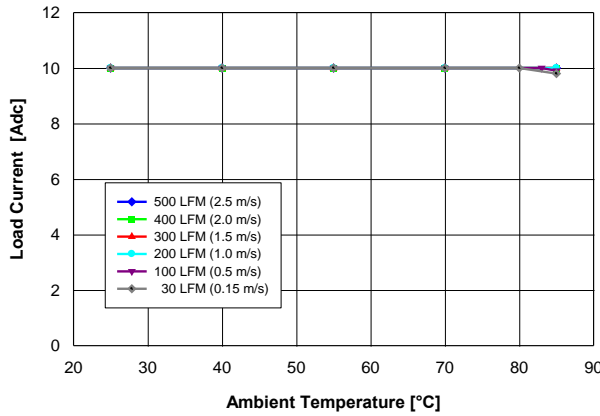


Fig. 1.8V.1: Available load current vs. ambient temperature and airflow rates for YNV12T10018 converter mounted vertically with $V_{in} = 12$ V, and maximum MOSFET temperature ≤ 120 °C.

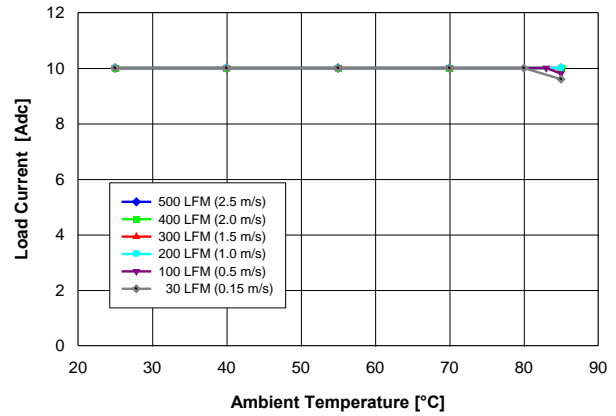


Fig. 1.8V.2: Available load current vs. ambient temperature and airflow rates for YNV12T10018 converter mounted horizontally with $V_{in} = 12$ V, and maximum MOSFET temperature ≤ 120 °C.

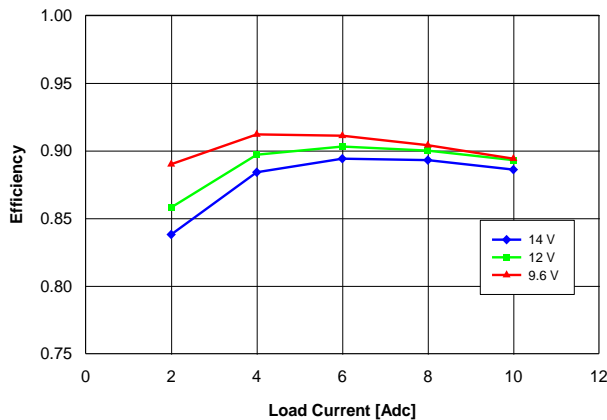


Fig. 1.8V.3: Efficiency vs. load current and input voltage for YNV12T10018 converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and $T_a = 25$ °C.

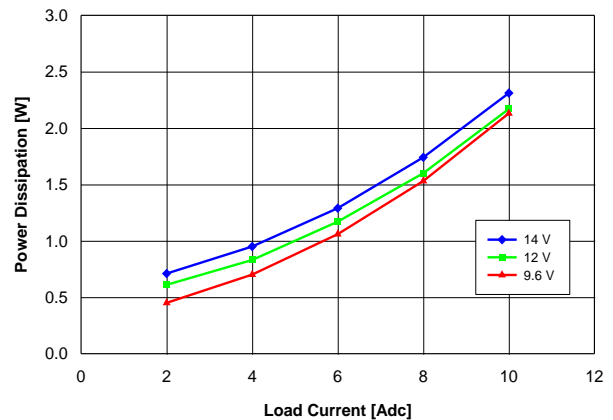


Fig. 1.8V.4: Power loss vs. load current and input voltage for YNV12T10018 converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and $T_a = 25$ °C.

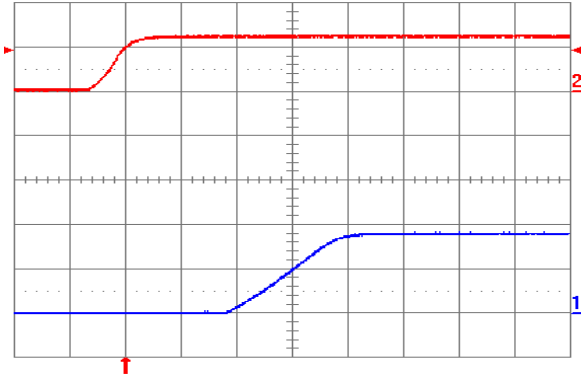


Fig. 1.8V.5: Turn-on transient (YNV12T10018) with application of V_{in} at full rated load current (resistive) and $100\ \mu\text{F}$ external capacitance at $V_{in} = 12\ \text{V}$. Top trace: V_{in} ($10\ \text{V/div.}$); Bottom trace: output voltage ($1\ \text{V/div.}$); Time scale: $2\ \text{ms/div.}$

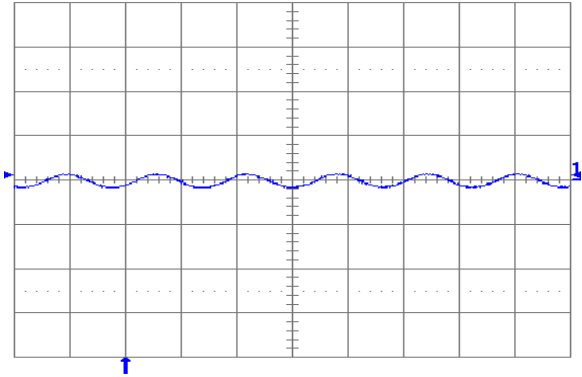


Fig. 1.8V.6: Output voltage ripple ($20\ \text{mV/div.}$) at full rated load current into a resistive load with external capacitance $100\ \mu\text{F}$ ceramic and $V_{in} = 12\ \text{V}$ (YNV12T10018). Time scale: $2\ \mu\text{s/div.}$

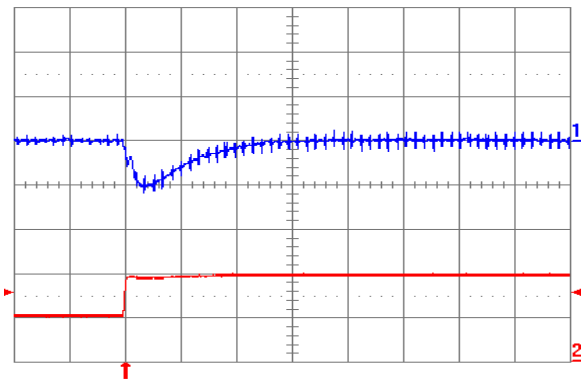


Fig. 1.8V.7: Output voltage response (YNV12T10018) to positive load current step change from $5\ \text{A}$ to $10\ \text{A}$ with slew rate of $5\ \text{A}/\mu\text{s}$ at $V_{in} = 12\ \text{V}$. Top trace: output voltage ($100\ \text{mV/div.}$); Bottom trace: load current ($5\ \text{A/div.}$). $C_o = 100\ \mu\text{F}$ ceramic. Time scale: $20\ \mu\text{s/div.}$

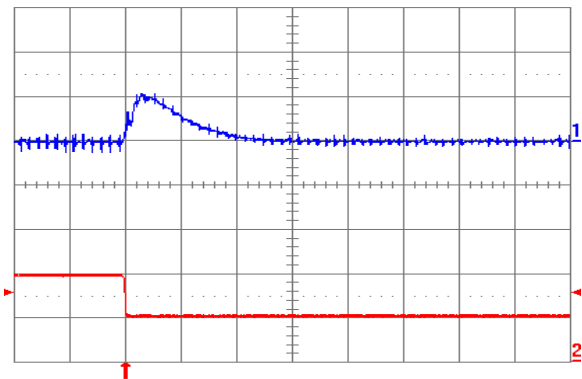


Fig. 1.8V.8: Output voltage response (YNV12T10018) to negative load current step change from $10\ \text{A}$ to $5\ \text{A}$ with slew rate of $-5\ \text{A}/\mu\text{s}$ at $V_{in} = 12\ \text{V}$. Top trace: output voltage ($100\ \text{mV/div.}$); Bottom trace: load current ($5\ \text{A/div.}$). $C_o = 100\ \mu\text{F}$ ceramic. Time scale: $20\ \mu\text{s/div.}$

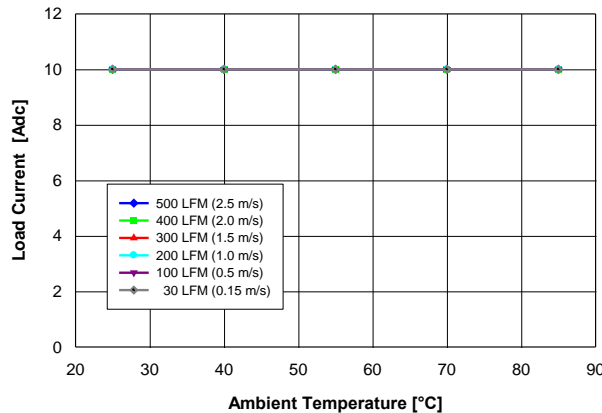


Fig. 1.5V.1: Available load current vs. ambient temperature and airflow rates for YNV12T10015 converter mounted vertically with $V_{in} = 12\ \text{V}$, and maximum MOSFET temperature $\leq 120\ ^\circ\text{C}$.

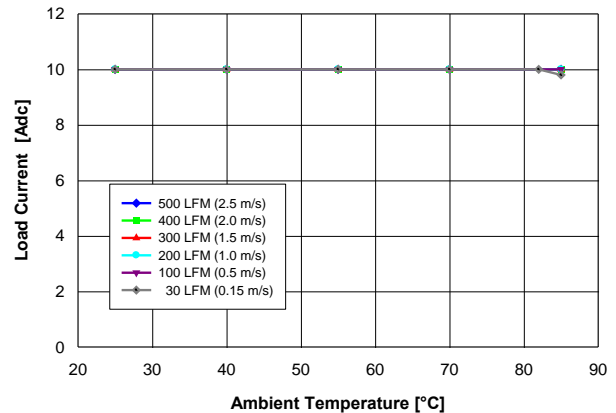


Fig. 1.5V.2: Available load current vs. ambient temperature and airflow rates for YNV12T10015 converter mounted horizontally with $V_{in} = 12\ \text{V}$, and maximum MOSFET temperature $\leq 120\ ^\circ\text{C}$.

YNV12T100xy DC-DC Converter

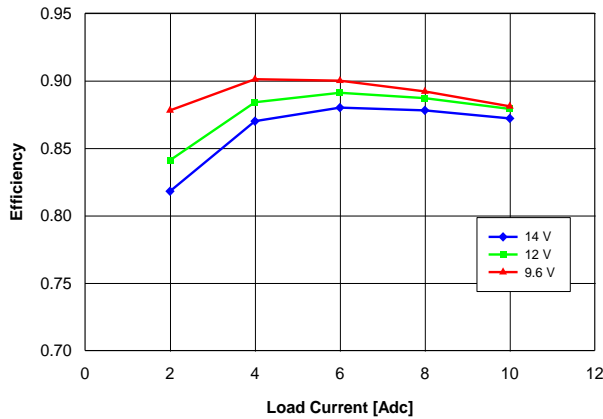


Fig. 1.5V.3: Efficiency vs. load current and input voltage for YNL05S10015 converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and $T_a = 25^\circ\text{C}$.

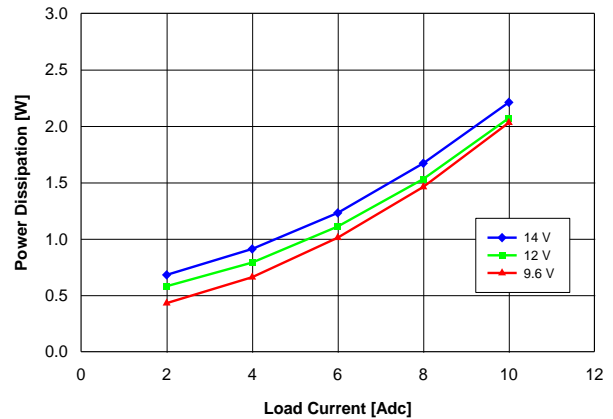


Fig. 1.5V.4: Power loss vs. load current and input voltage for YNV12T10015 converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and $T_a = 25^\circ\text{C}$.

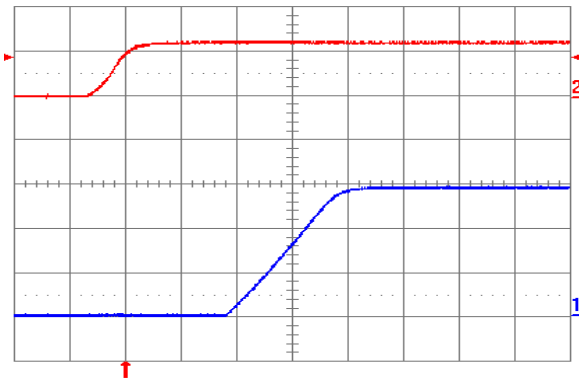


Fig. 1.5V.5: Turn-on transient (YNV12T10015) with application of V_{in} at full rated load current (resistive) and $100\ \mu\text{F}$ external capacitance at $V_{in} = 12\ \text{V}$. Top trace: V_{in} (10 V/div.); Bottom trace: output voltage (0.5 V/div.); Time scale: 2 ms/div.

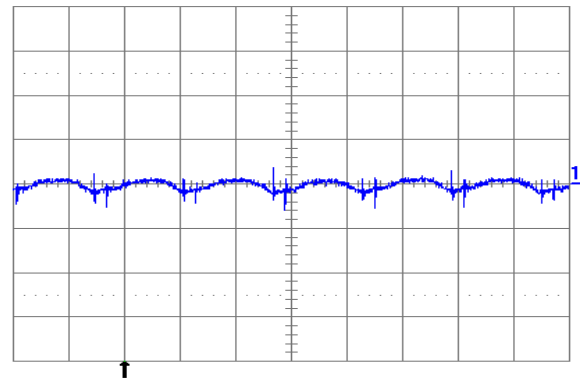


Fig. 1.5V.6: Output voltage ripple (20 mV/div.) at full rated load current into a resistive load with external capacitance $100\ \mu\text{F}$ ceramic and $V_{in} = 12\ \text{V}$ (YNV12T10015). Time scale: 2 μs /div.

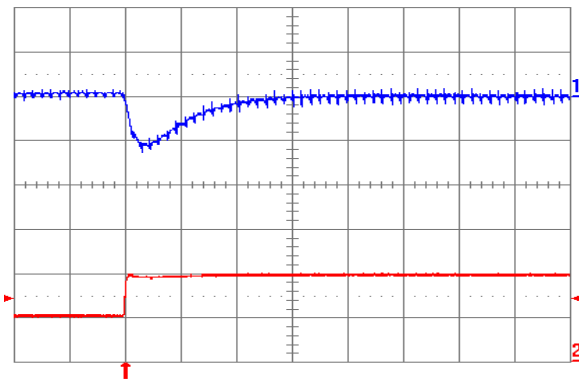


Fig. 1.5V.7: Output voltage response (YNV12T10015) to positive load current step change from 5 A to 10 A with slew rate of $5\ \text{A}/\mu\text{s}$ at $V_{in} = 12\ \text{V}$. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). $C_o = 100\ \mu\text{F}$ ceramic. Time scale: 20 μs /div.

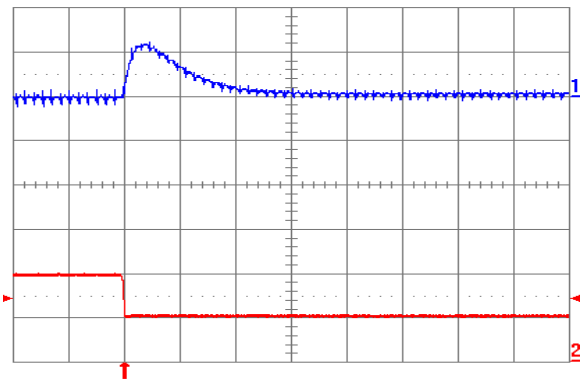


Fig. 1.5V.8: Output voltage response (YNV12T10015) to negative load current step change from 10 A to 5 A with slew rate of $-5\ \text{A}/\mu\text{s}$ at $V_{in} = 12\ \text{V}$. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). $C_o = 100\ \mu\text{F}$ ceramic. Time scale: 20 μs /div.

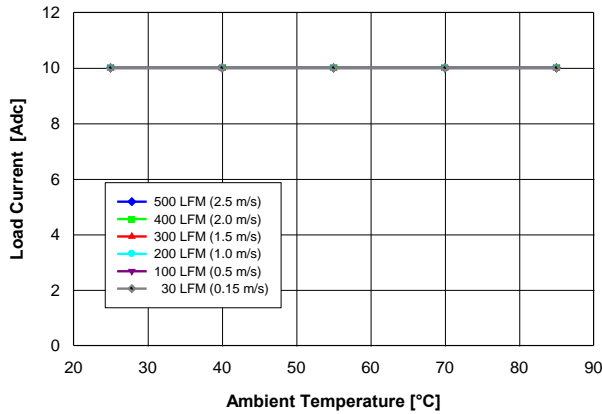


Fig. 1.2V.1: Available load current vs. ambient temperature and airflow rates for YNV12T10012 converter mounted vertically with $V_{in} = 12\text{ V}$, and maximum MOSFET temperature $\leq 120\text{ }^{\circ}\text{C}$.

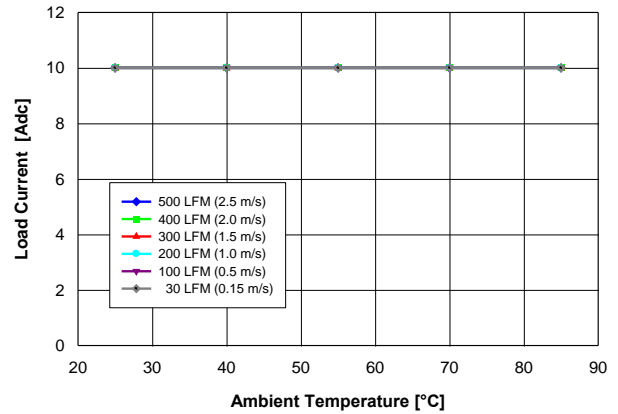


Fig. 1.2V.2: Available load current vs. ambient temperature and airflow rates for YNV12T10012 converter mounted horizontally with $V_{in} = 12\text{ V}$, and maximum MOSFET temperature $\leq 120\text{ }^{\circ}\text{C}$.

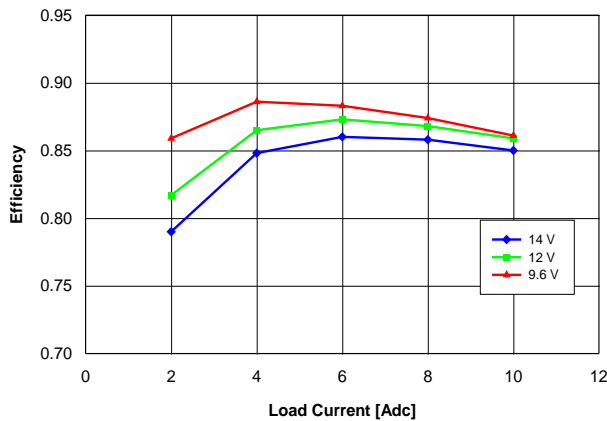


Fig. 1.2V.3: Efficiency vs. load current and input voltage for YNV12T10012 converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and $T_a = 25\text{ }^{\circ}\text{C}$.

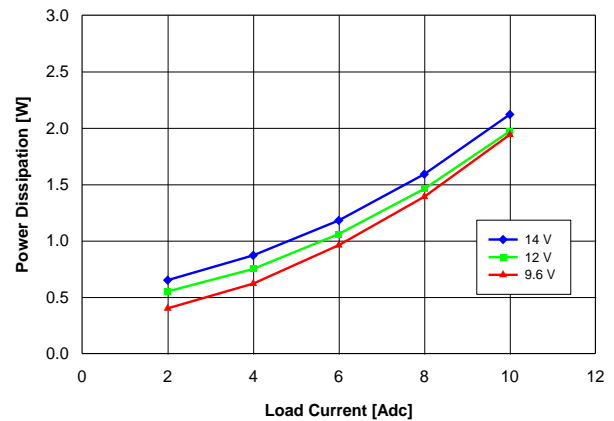


Fig. 1.2V.4: Power loss vs. load current and input voltage for YNV12T10012 converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and $T_a = 25\text{ }^{\circ}\text{C}$.

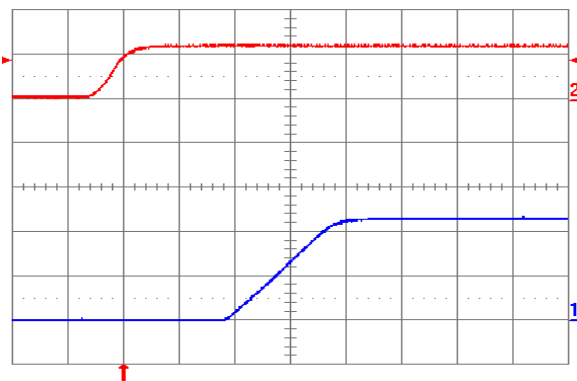


Fig. 1.2V.5: Turn-on transient (YNV12T10012) with application of V_{in} at full rated load current (resistive) and $100\text{ }\mu\text{F}$ external capacitance at $V_{in} = 12\text{ V}$. Top trace: V_{in} (10 V/div.); Bottom trace: output voltage (0.5 V/div.); Time scale: 2 ms/div.

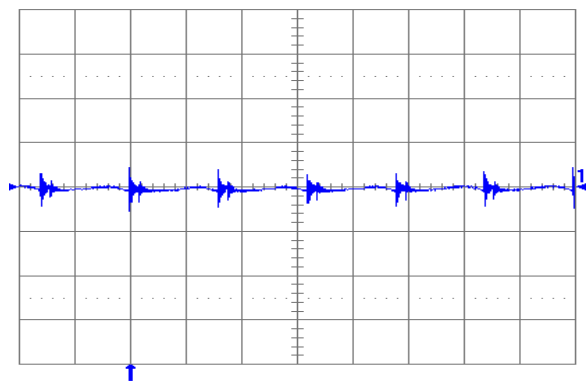


Fig. 1.2V.6: Output voltage ripple (20mV/div.) at full rated load current into a resistive load with external capacitance $100\text{ }\mu\text{F}$ ceramic and $V_{in} = 12\text{ V}$ (YNV12T10012). Time scale: 2 μs /div.

YNV12T100xy DC-DC Converter

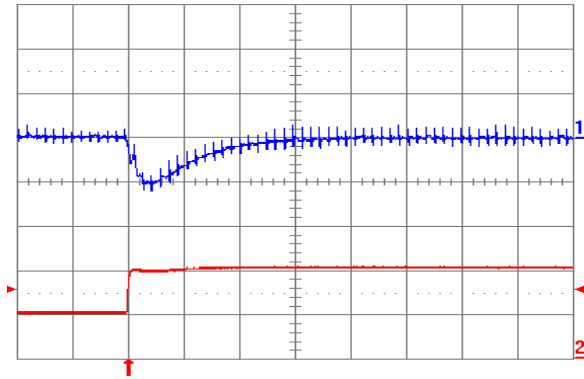


Fig. 1.2V.7: Output voltage response (YNV12T10012) to positive load current step change from 5 A to 10 A with slew rate of 5 A/μs at $V_{in} = 12$ V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). $C_o = 100$ μF ceramic. Time scale: 20 μs/div.

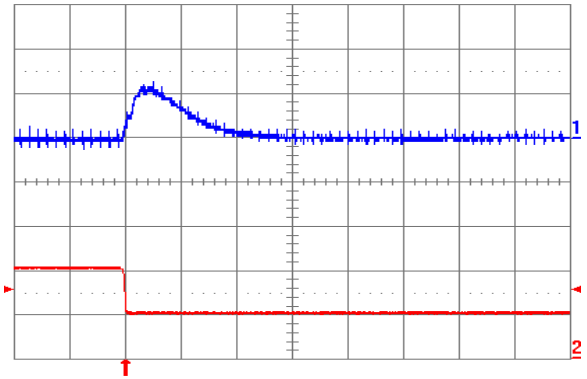


Fig. 1.2V.8: Output voltage response (YNV12T10012) to negative load current step change from 10 A to 5 A with slew rate of -5 A/μs at $V_{in} = 12$ V. Top trace: output voltage (100 mV/div.); Bottom trace: load current (5 A/div.). $C_o = 100$ μF ceramic. Time scale: 20 μs/div.

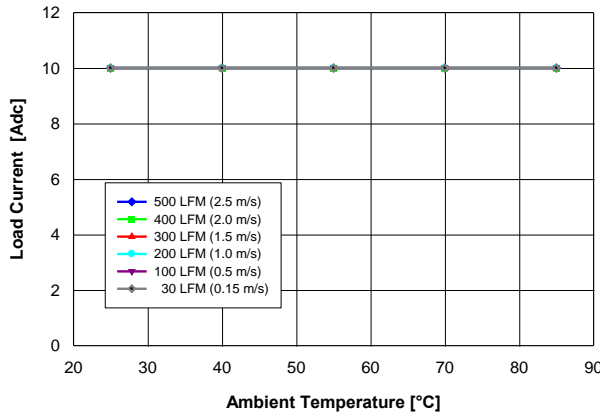


Fig. 1.0V.1: Available load current vs. ambient temperature and airflow rates for YNV12T10010 converter mounted vertically with $V_{in} = 12$ V, and maximum MOSFET temperature ≤ 120 °C.

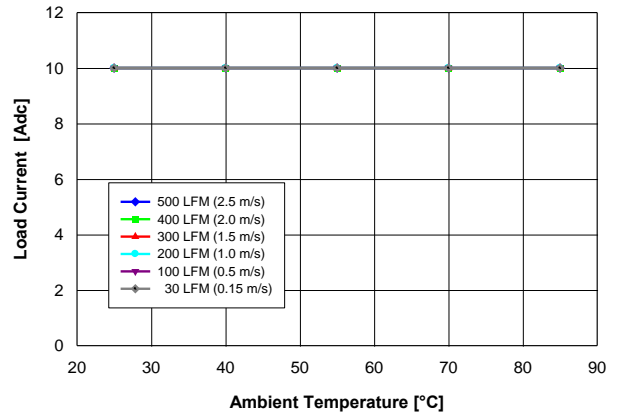


Fig. 1.0V.2: Available load current vs. ambient temperature and airflow rates for YNV12T10010 converter mounted horizontally with $V_{in} = 12$ V, and maximum MOSFET temperature ≤ 120 °C.

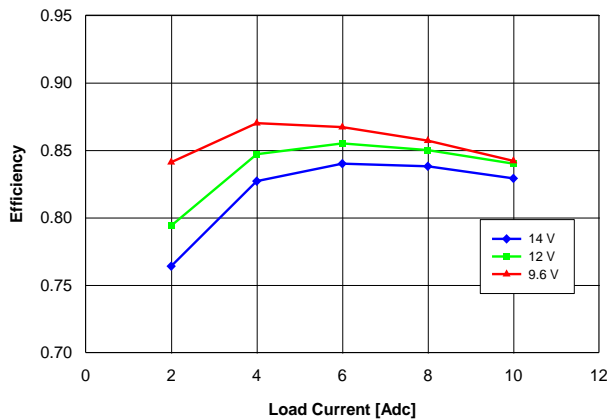


Fig. 1.0V.3: Efficiency vs. load current and input voltage for YNL05S10010 converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and $T_a = 25$ °C.

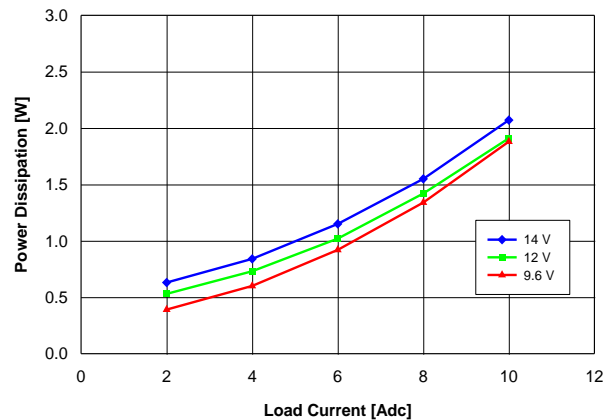


Fig. 1.0V.4: Power loss vs. load current and input voltage for YNV12T10010 converter mounted vertically with air flowing at a rate of 200 LFM (1 m/s) and $T_a = 25$ °C.

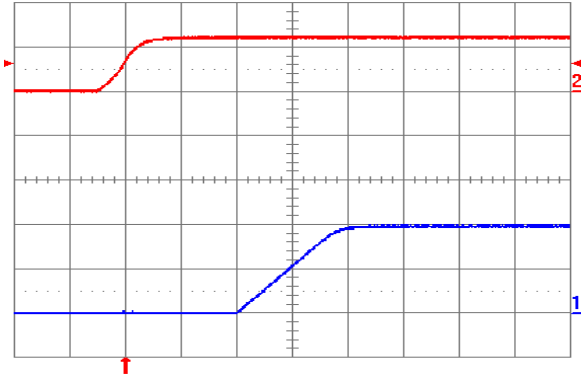


Fig. 1.0V.5: Turn-on transient (YNV12T10010) with application of V_{in} at full rated load current (resistive) and $100\ \mu\text{F}$ external capacitance at $V_{in} = 12\ \text{V}$. Top trace: V_{in} ($10\ \text{V/div.}$); Bottom trace: output voltage ($0.5\ \text{V/div.}$); Time scale: $2\ \text{ms/div.}$

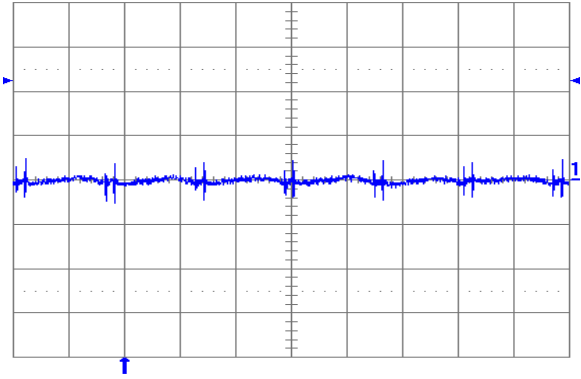


Fig. 1.0V.6: Output voltage ripple ($20\ \text{mV/div.}$) at full rated load current into a resistive load with external capacitance $100\ \mu\text{F}$ ceramic and $V_{in} = 12\ \text{V}$ (YNV12T10010). Time scale: $2\ \mu\text{s/div.}$

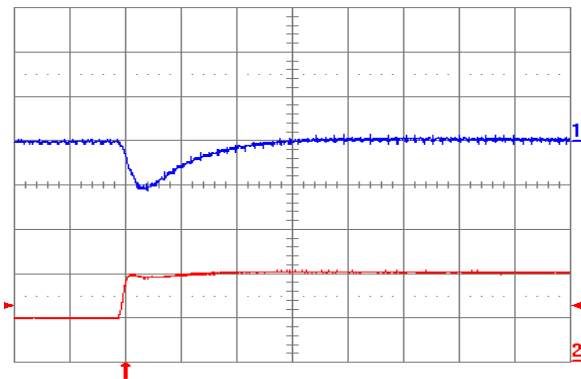


Fig. 1.0V.7: Output voltage response (YNV12T10010) to positive load current step change from $5\ \text{A}$ to $10\ \text{A}$ with slew rate of $5\ \text{A}/\mu\text{s}$ at $V_{in} = 12\ \text{V}$. Top trace: output voltage ($100\ \text{mV/div.}$); Bottom trace: load current ($5\ \text{A/div.}$). $C_o = 100\ \mu\text{F}$ ceramic. Time scale: $20\ \mu\text{s/div.}$

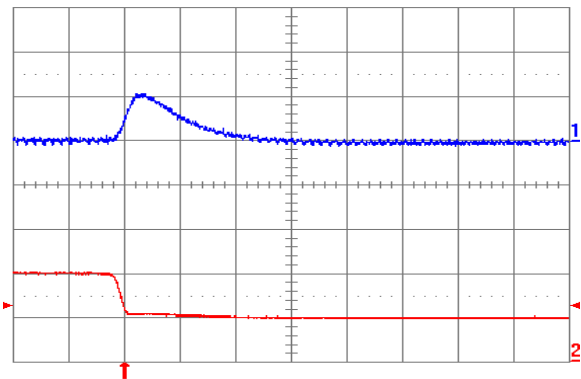
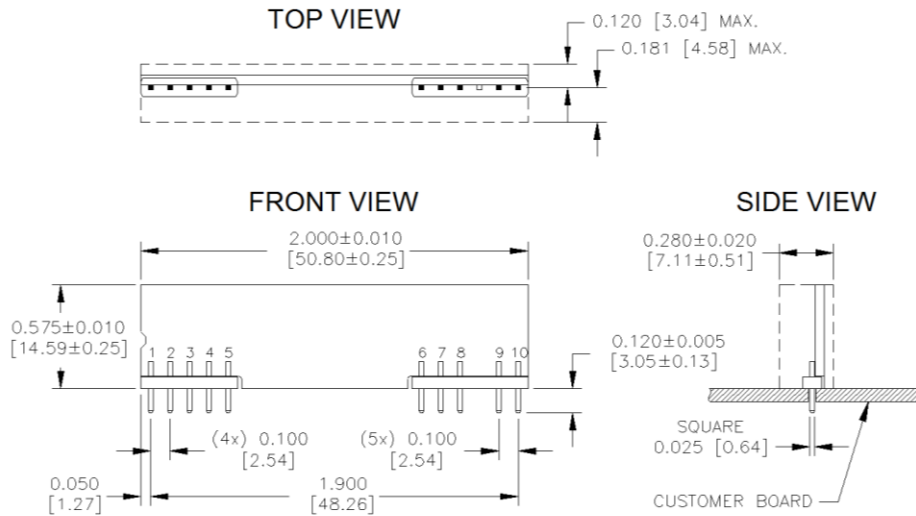


Fig. 1.0V.8: Output voltage response (YNV12T10010) to negative load current step change from $10\ \text{A}$ to $5\ \text{A}$ with slew rate of $-5\ \text{A}/\mu\text{s}$ at $V_{in} = 12\ \text{V}$. Top trace: output voltage ($100\ \text{mV/div.}$); Bottom trace: load current ($5\ \text{A/div.}$). $C_o = 100\ \mu\text{F}$ ceramic. Time scale: $20\ \mu\text{s/div.}$

PHYSICAL INFORMATION



PAD/PIN CONNECTIONS	
Pad/Pin #	Function
1	Vout
2	Vout
3	Vout SENSE
4	Vout
5	GND
6	GND
7	Vin
8	Vin
9	TRIM
10	ON/OFF

YNV12T100xy Pinout (Through-Hole - SIP)

YNV12T100xy Platform Notes

- All dimensions are in inches [mm]
- Connector Material: Copper
- Connector Finish: Gold
- Converter Weight: 0.25 oz [7 g]
- Converter Height: 0.585" Max.
- Recommended Through Hole Via/Pad: Min. 0.043" X 0.064" [1.09 x 1.63]

ORDERING INFORMATION

Product Series	Input Voltage	Mounting Scheme	Rated Load Current	Output Voltage	-	Enable Logic	RoHS
YNV	12	T	10	025	-	0	
Y-Series	9.6 - 14 VDC	T ⇒ Through-Hole (SIP)	10 ADC (1.0 V to 5.0 V)	010 ⇒ 1.0 V 012 ⇒ 1.2 V 015 ⇒ 1.5 V 018 ⇒ 1.8 V 020 ⇒ 2.0 V 025 ⇒ 2.5 V 033 ⇒ 3.3 V 050 ⇒ 5.0 V		0 ⇒ Standard (Positive Logic) D ⇒ Opposite of Standard (Negative Logic)	No Suffix ⇒ RoHS lead solder exemption compliant G ⇒ RoHS compliant for all six substances

The example above describes P/N YNV12T10025-0 which has a 9.6V – 14V input, through-hole (SIP), 10A @ 2.5V output, standard enable logic, and RoHS lead-solder exemption compliance. Please consult factory regarding availability of a specific version.

Model numbers highlighted in yellow or shaded are not recommended for new designs.

For more information on these products consult: tech.support@psbel.com

NUCLEAR AND MEDICAL APPLICATIONS - Products are not designed or intended for use as critical components in life support systems, equipment used in hazardous environments, or nuclear control systems.

TECHNICAL REVISIONS - The appearance of products, including safety agency certifications pictured on labels, may change depending on the date manufactured. Specifications are subject to change without notice.